

FFPF10UP20S 10 A, 200 V, Ultrafast Diode

Features

- Ultrafast Recovery t_{rr} = 35 ns (@ I_F = 1 A)
- Max Forward Voltage, $V_F = 1.15 \text{ V } (@ T_C = 25^{\circ}\text{C})$
- Reverse Voltage, V_{RRM} = 200 V
- · Avalanche Energy Rated
- · RoHS Compliant

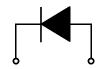
Applications

- · Power Switching Circuits, SMPS
- · Output Rectifiers
- · Freewheeling Diodes

Description

The FFPF10UP20S is an ultrafast diode with low forward voltage drop and rugged UIS capability. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial applications as welder and UPS application.





1. Cathode 2. Anode

Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter	Rating	Unit	
V_{RRM}	Peak Repetitive Reverse Voltage	200	V	
V_{RWM}	orking Peak Reverse Voltage 200			
I _{F(AV)}	Average Rectified Forward Current @ T _C = 25°C	10	Α	
I _{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave			
T _J , T _{STG}	Operating Junction and Storage Temperature -65 to +175			

Thermal Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Max.	Unit
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	4.3	°C/W

Package Marking and Ordering Information

Part Number Top Mark		Package	Packing Method	Reel Size	Tape Width	Quantity
FFPF10UP20STU	FFPF10UP20S	TO-220F-2L	Tube	N/A	N/A	50

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted

Symbol	Parameter		Min.	Тур.	Max.	Unit
V _F ¹	Forward Voltage I _F = 10 A I _F = 10 A	$T_{C} = 25^{\circ}C$ $T_{C} = 125^{\circ}C$			- 1.15 - 1.10	V
I _R ¹	Reverse Current @ rated V _R	$T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$			100 500	μА
t _{rr} I _{rr} Q _{rr}	Reverse Recovery Time Reverse Recovery Current Reverse Recovery Charge (I _F = 6 A, di _F /dt = 200 A/µs, V _R = 130 V)	T _C = 25°C		32 1.65 24.4	- - -	ns A nC
W _{AVL}	Avalanche Energy (L = 40 mH)		5	-	-	mJ

Test Circuit and Waveforms

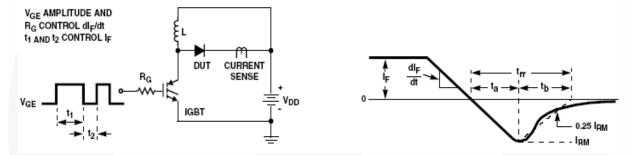


Figure 1. Diode Reverse Recovery Test Circuit & Waveform

L = 40mH R < 0.1Ω $V_{DD} = 50V$ $\mathsf{EAVL} = 1/2\mathsf{LI2} \; [\mathsf{V}_{\mathsf{R}(\mathsf{AVL})}/(\mathsf{V}_{\mathsf{R}(\mathsf{AVL})} - \mathsf{V}_{\mathsf{DD}})]$ Q1 = IGBT (BVCES > DUT VR(AVL)) V_{AVL} CURRENT SENSE V_{DD} DUT t2 t1

Figure 2. Unclamped Inductive Switching Test Circuit & Waveform

Notes: 1: Pulse: Test Pulse width = $300\mu s$, Duty Cycle = 2%

Typical Performance Characteristics

Figure 3. Typical Forward Voltage Drop vs. Forward Current

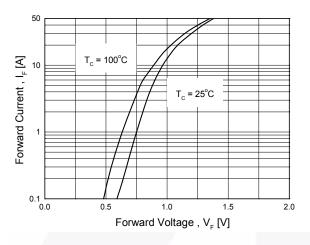


Figure 4. Typical Reverse Current vs. Reverse Voltage

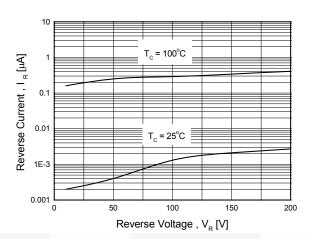


Figure 5. Typical Junction Capacitance

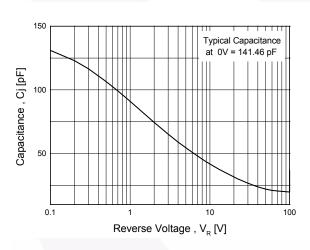


Figure 6. Typical Reverse Recovery Time vs. di_F/dt

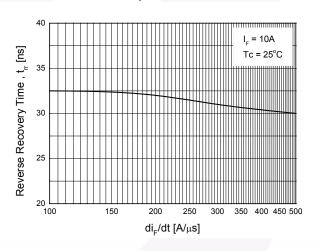


Figure 7. Typical Reverse Recovery Current vs. di_F/dt

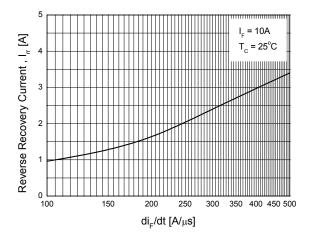
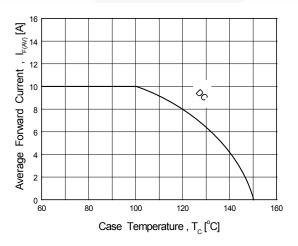


Figure 8. Forward Current Derating Curve



Mechanical Dimensions

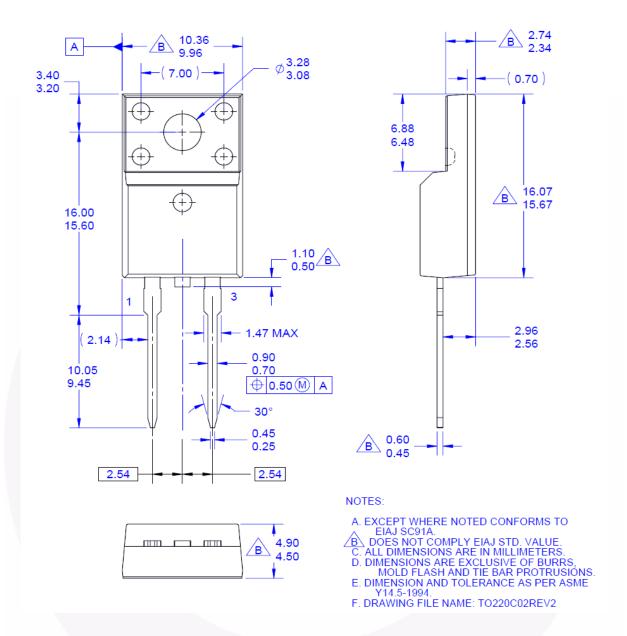


Figure 9. TO-220F 2L - 2LD; TO220; MOLDED; FULL PACK

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Rev. 171